

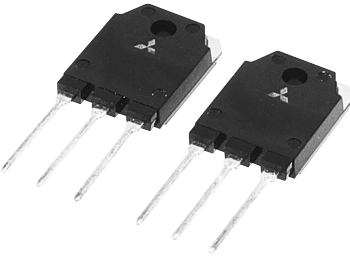
PRELIMINARY
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MITSUBISHI Pch POWER MOSFET

FX3SMJ-3

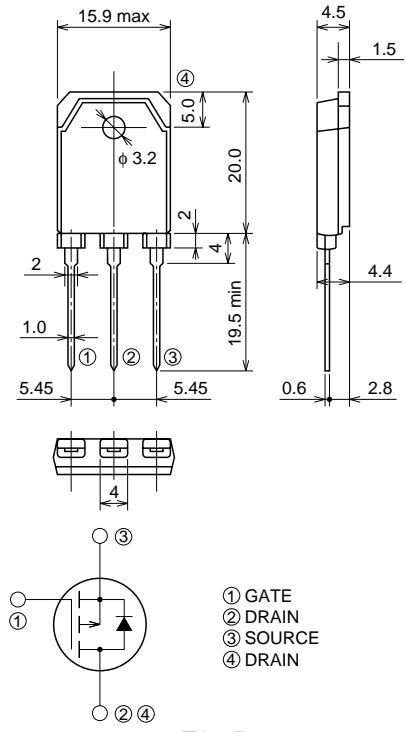
HIGH-SPEED SWITCHING USE

FX3SMJ-3



- 4V DRIVE
- V_{DSS} -150V
- $r_{DS(ON)}$ (MAX) 1.2 Ω
- I_D -3A
- Integrated Fast Recovery Diode (TYP.) 80ns

OUTLINE DRAWING Dimensions in mm



① GATE
 ② DRAIN
 ③ SOURCE
 ④ DRAIN

TO-3P

APPLICATION

Motor control, Lamp control, Solenoid control
 DC-DC converter, etc.

MAXIMUM RATINGS (Tc = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V_{DSS}	Drain-source voltage	$V_{GS} = 0V$	-150	V
V_{GSS}	Gate-source voltage	$V_{DS} = 0V$	± 20	V
I_D	Drain current		-3	A
I_{DM}	Drain current (Pulsed)		-12	A
I_{DA}	Avalanche drain current (Pulsed)	$L = 100\mu H$	-3	A
I_S	Source current		-3	A
I_{SM}	Source current (Pulsed)		-12	A
P_D	Maximum power dissipation		30	W
T_{ch}	Channel temperature		-55 ~ +150	°C
T_{stg}	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	4.8	g

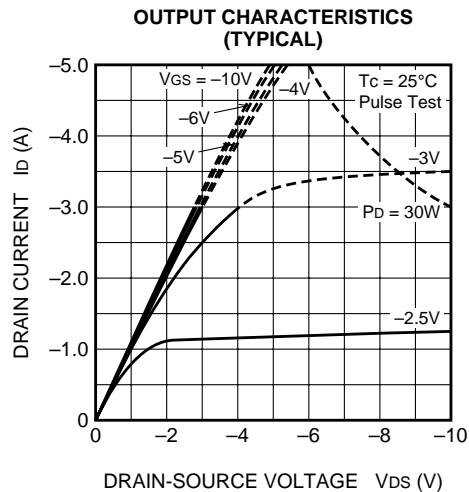
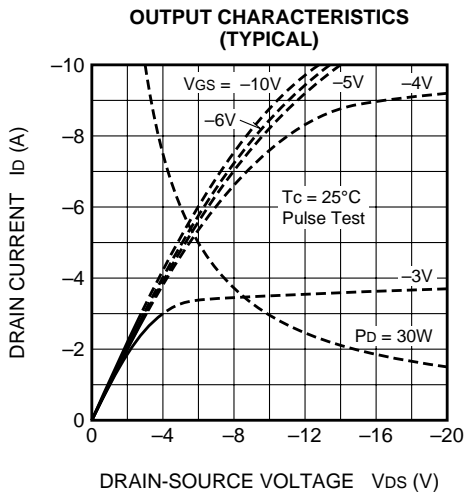
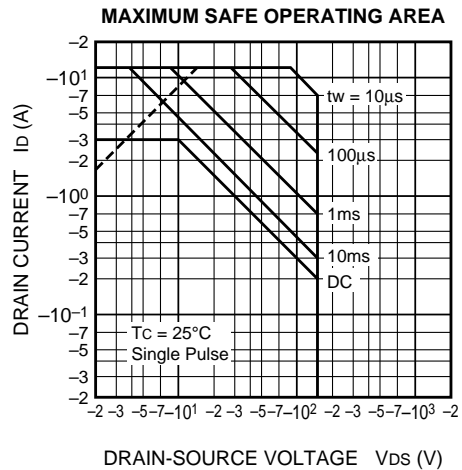
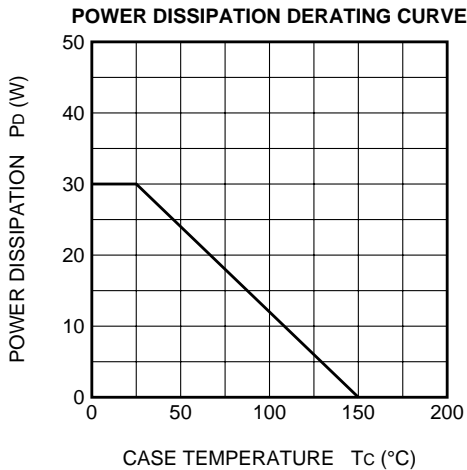
Jan.1999

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ELECTRICAL CHARACTERISTICS (Tch = 25°C)

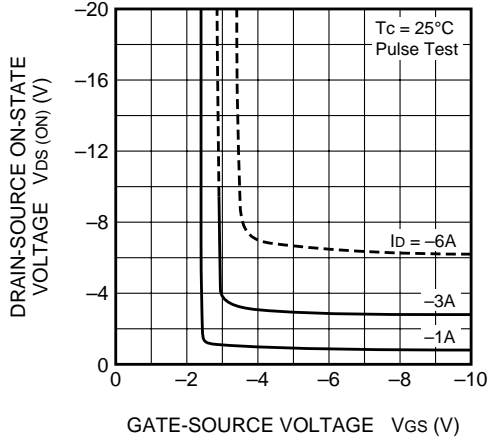
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	ID = -1mA, VGS = 0V	-150	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = -150V, VGS = 0V	—	—	-0.1	mA
VGS(th)	Gate-source threshold voltage	ID = -1mA, VDS = -10V	-1.0	-1.5	-2.0	V
rDS(ON)	Drain-source on-state resistance	ID = -1A, VGS = -10V	—	0.93	1.20	Ω
rDS(ON)	Drain-source on-state resistance	ID = -1A, VGS = -4V	—	1.02	1.32	Ω
VDS(ON)	Drain-source on-state voltage	ID = -1A, VGS = -10V	—	-0.93	-1.20	V
yfs	Forward transfer admittance	ID = -1A, VDS = -5V	—	3.0	—	S
Ciss	Input capacitance	VDS = -10V, VGS = 0V, f = 1MHz	—	1170	—	pF
Coss	Output capacitance		—	81	—	pF
Crss	Reverse transfer capacitance		—	31	—	pF
td(on)	Turn-on delay time		—	9	—	ns
tr	Rise time	VDD = -80V, ID = -1A, VGS = -10V, RGEN = RGS = 50Ω	—	7	—	ns
td(off)	Turn-off delay time		—	82	—	ns
tf	Fall time		—	33	—	ns
VSD	Source-drain voltage		IS = -1A, VGS = 0V	—	-1.0	-1.5
Rth(ch-c)	Thermal resistance	Channel to case	—	—	4.17	°C/W
trr	Reverse recovery time	IS = -3A, dis/dt = 100A/μs	—	80	—	ns

PERFORMANCE CURVES

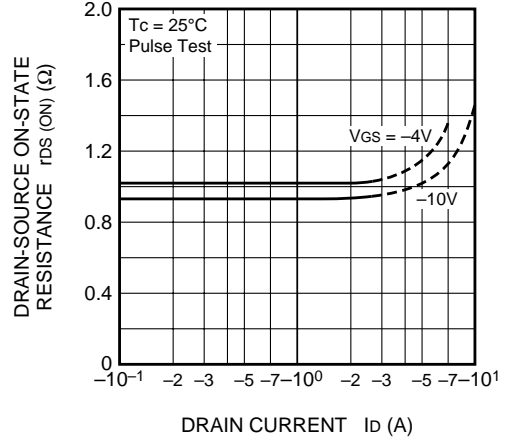


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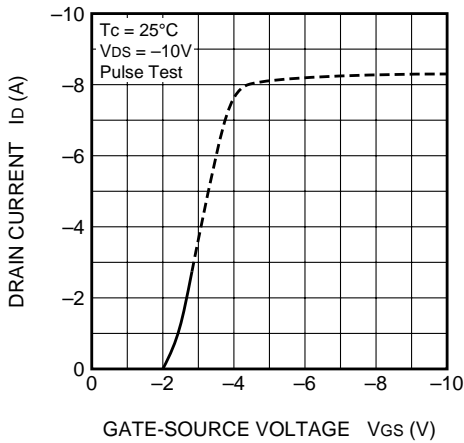
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



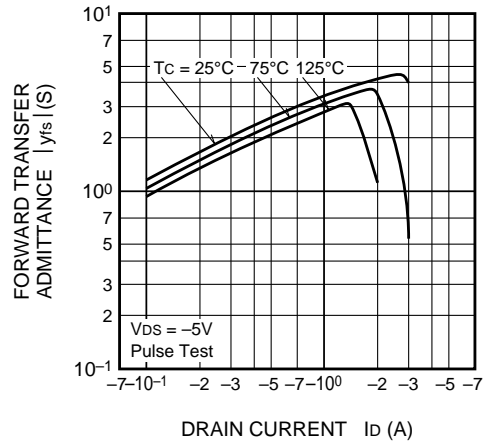
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



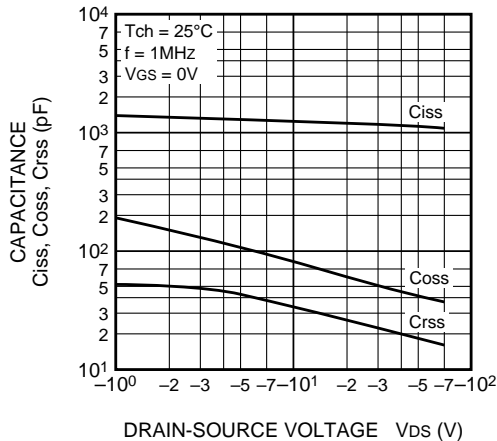
TRANSFER CHARACTERISTICS (TYPICAL)



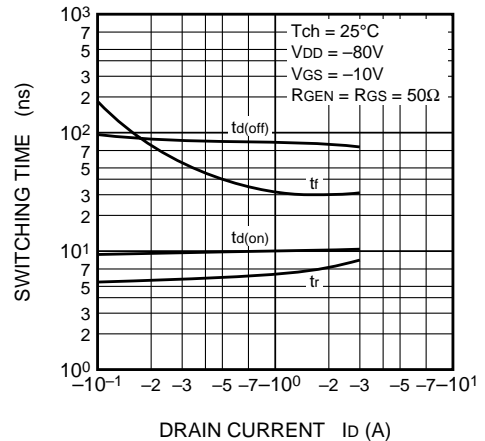
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)



SWITCHING CHARACTERISTICS (TYPICAL)



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